

Surge arrester

2-electrode arrester

Series/Type: EN1200XSMD Ordering code: B88069X5141T702

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2-electrode arrester EN1200XSMD

Features

- Standard size
- Fast response time
- Stable performance over life
- Very low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications

- Modem
- XDSL-splitter
- Consumer electronic
- Tuner

Electrical specifications

Lieuticai specifications			
DC spark-over voltage 1) 2) Tolerance Min. Max.		1200 ±15 1020 1380	V % V
Impulse spark-over voltage at 100 V/µs - for 99% of measured values - typical values of distribution at 5 kV/µs - for 99% of measured values		< 1500 < 1350 < 1600	V V
- typical values of distribution		< 1450	V
Service life 5 operations 10 operations [5x (+) & 5x (-)] 100 operations	50 Hz, 1 s 8/20 μs 10/1000 μs	5 5 100	A kA A
DC hold-over voltage at 135 V_{DC} / 1300 Ω		< 150	ms
Insulation resistance at 100 V _{DC}		> 1	GΩ
Capacitance at 1 MHz		< 1	pF
Arc voltage at 1 A Glow to arc transition current Glow voltage at 0.1 A		~ 30 < 0.5 ~ 200	V A V
Weight		~ 0.5	g
Operation and storage temperature		-40 + 125	°C
Climatic category (IEC 60068-1)		40/125/21	
Marking, blue positive		EPCOS EN 1200 YY O EN - Series 1200 - Nominal voltage YY - Year of production O - Non radioactive	

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

Terms in accordance with ITU-T Rec. K.12; IEC 61663-2 and IEC 61643-311.

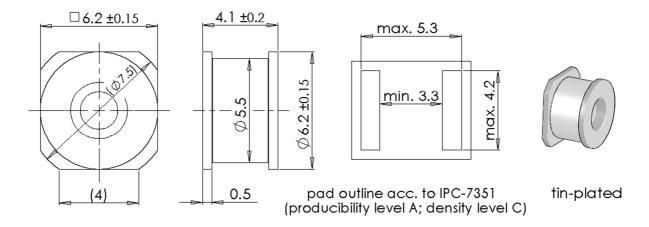
²⁾ In ionized mode



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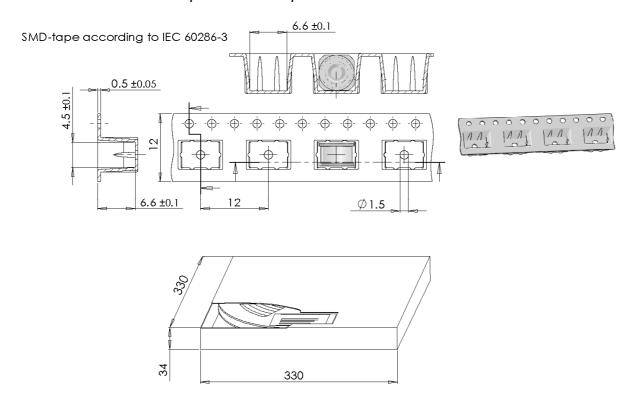
EN1200XSMD

Dimensional drawing in mm



Ordering code and packing advice

B88069X5141**T702** = 700 pcs. on SMD-tape & reel



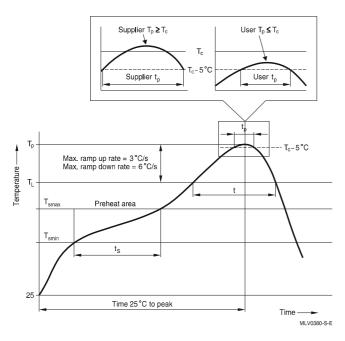


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Soldering parameter

Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	T_{smin} T_{smax} t_{smin} to t_{smax}	100 °C 150 °C 60 120 s	150 °C 200 °C 60 180 s
Average ramp-up rate	T_{smax} to T_p	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature Time at liquidous	T _L	183 °C 60 150 s	217 °C 60 150 s
Peak package body temperature *, Classification temperature **	T_p,T_C	220 235 °C **	245 260 °C **
Time (t _p) ** within 5 °C of the specified classification temperature (T _C)		20 s ***	30 s ***
Average ramp-down rate	T _p to T _{smax}	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min

f = Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Electromagnetic fields and ionizing radiation may affect the electrical characteristics of the arrester. The impact of such effects (inductive and capacitive field distortion from adjacent components) must be avoided by appropriate circuit design measures.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- If the contacts of the surge arresters are defective, current load can cause sparks and loud noises.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

^{** =} For details please refer to JEDEC J-STD-020D.

^{*** =} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.



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